Model 406 Single Element Pyroelectric IR Detector With Source Follower



Manufactured under one or more of the following U.S. patents: 3,839,640 - 4,218,620 - 4,326,663 - 4,384,207 - 4,437,003 - 4,441,023 - 4,523,095

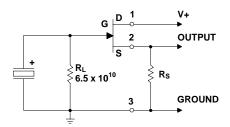
Model 406 contains a single lithium tantalate sensing element and a JFET source follower sealed into a standard TO-5 transistor package with an optical filter.

A patented element mounting technique is used to improve thermal time constant and reduce effects of microphony.

A source resistor is needed to set the drain current and consequently the operating parameters of the JFET. A $47k\Omega$ or greater value resistor is recommended.

Applications

- Motion Sensing
- Lighting Control
- Intrusion Detection
- Industrial Control
- Gas Analysis
- Heating/AC Control
- Pyrometry
- · Low-power Laser Detection
- Robotics
- Instrumentation





PIN DESIGNATIONS

1. V+ 2. OUTPUT

2. GUIPUI

360
(9.14)
DIA
.320
(8.13)
DIA
.180 SQ APERTURE
(4.57)
.125
(3.18)
NOM
.190
.53
(4.83)
.53
(13)

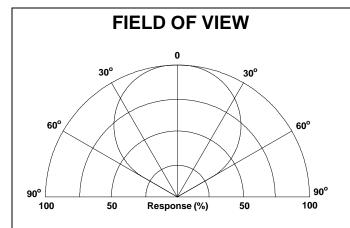
DIMENSIONS IN INCHES (mm)

PINS CIRCLE .200 (5.08); LEAD DIA .017 (0.43)

Characteristics		406	Unit	Test Conditions	ELTECdata Reference
Detector Type		Single			
Element Size		2.0	mm, Dia		
Optical Bandwidth		0.1 to 1,000	μm	Various Filters	101
Responsivity	(min) (typ)	2100 2350	V/W	8 to 14 μm, 1Hz	
Noise	(typ) (max)	2.0 4.3	μVrms/√ Hz	1Hz	
NEP	(typ) (max)	8.5 x 10 ⁻¹⁰ 2.0 x 10 ⁻⁹	W/√Hz	8 to 14 μm, 1Hz, 1Hz BW	100
D*	(min) (typ)	0.9 x 10 ⁸ 2.1 x 10 ⁸	cm√Hz/W	8 to 14 μm, 1Hz, 1Hz BW	100
Operating Voltage	(min) (max)	3 15	VDC	V+ to Gnd	104 (4.1.c)
Operating Current	(min) (max)	3 12	μА	R _S =100kΩ	104 (4.1.c)
Offset Voltage	(min) (max)	0.3 1.2	V	R _S =100kΩ	106 Section B
Output Impedance		<r<sub>S</r<sub>	Ω		
Thermal Breakpoint f _T (typ)		0.25	Hz		102
Electrical Breakpoint f _e (typ)		0.08	Hz	$R_L=6.5 \times 10^{10}\Omega$	102
Recommended Operating Temperature		-10 to +50	°C	Functional	
Storage Temperature		-55 to +125	°C	ΔT<50C ^o /min	
Output Protection		Do not exceed a maximum drain current of 50 μA			

Characteristics at 25°C, with -3 filter, V+= 5 VDC, R_S =100k Ω unless otherwise stated. Data is established on a sample basis and is believed to be representative.

BOTTOM VIEW



For -3 filter only. For other filters, consider refractive index and thickness.

Symmetrical crystal gives same FOV in vertical and horizontal planes.

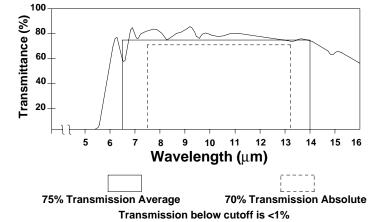
For best results, the following precautions and recommendations should be observed. (See ELTECdata #101):

Mounting: Avoid mechanical stresses on case and leads.

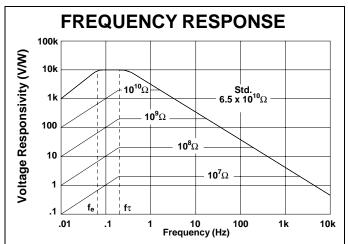
Soldering: Detectors must be hand soldered to minimize the chance of destroying the internal components. Avoid machine or hot air soldering. Leave a minimum lead length of .250 inch (6.35mm). When soldering to detector leads, use a heat sink between the case and leads. Beware that the new RoHS compliant solders require a higher soldering temperature making heat sinking the detector extremely important.

Static Discharge: Protect detectors from electro-static charges.

Transmission Characteristics of -3 Filter (HP7)



For information on other standard filters available, refer to ELTECdata #101.



The voltage response of this detector is dependent on the pulse rate or equivalent frequency of input. The frequency response of the detector can be linerarized by using a lower value resistor, but at the expense of lower responsivity and a lower D*. Load resistor values other than the standard 6.5 x $10^{10}\,\Omega$ can be specified.

Thermal Shock: Temperature changes and rate of change must be kept to a minimum (<50C⁰/min.) to prevent damage.

Noise: As a resolution or lower information limit, noise is established not only by the detector. Other noise sources are:

- Radiated and conducted RF signals
- · Subsequent amplification or signal conditioning stages
- · Power supply noise
- Components, such as high value resistors and capacitors (tantalum and aluminum electrolytic)
- · Mechanical contacts and weak solder joints
- Shock and vibration excited microphonics
- Outside thermal influences on the detector other than the desired infrared input, i.e. drafts

All of these noise sources should be considered carefully when the information signal is <1mV.

Light Leakage: Slight sensitivity to visible light leaking through the glass-to-metal seal on the base may be observed.

Optical Design: Use of a detector with a filter in an optical system may require consideration of the image displacement toward the filter. This displacement (s) caused by the insertion of a planoparallel plate (filter thickness = t; refractive index = N) is given by s = (t/N)(N-1).

NOTICE: The information provided herein is believed to be reliable. However, ELTEC Instruments, Inc. assumes no responsibility for inaccuracies or omissions. Due to industry components being incorporated into ELTEC's devices and ELTEC continually striving for product improvement, specifications may change without notice.



ELTEC Instruments, Inc. P.O. Box 9610 Daytona Beach, Florida 32120-9610 U.S.A.

Tel (USA and Canada): (800) 874-7780 Tel (Outside USA): (386) 252-0411 Fax: (386) 258-3791

Web: www.eltecinstruments.com E-Mail: Sales@eltecinstruments.com